

## "X300" Series, ECL High Reliability Hybrid Microcircuit Crystal Oscillators

### Features

- Ruggedized Crystal Mount
- Radiation Tolerant to 10K Rads
- 100% Screening Options
- Low Phase Noise
- Hermetically Sealed Metal Package
- ECCN: EAR99

## Applications

- High Shock & Vibration Applications
- Navigation Systems
- Aerospace Instrumentation
- Benign Space Applications
- Gun Launched Munitions

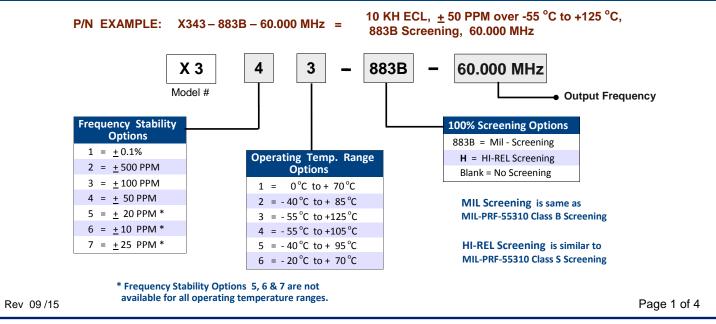
## Package Specifications & Outline:

- Header & Leads Material: Kovar
- Cover Material: Nickel
- Seal: Hermetic Resistance Welded
- Weight: 4.0 Gms typical, 5.0 Gms Max.
- Thermal Resistance, Junction to Case (  $\theta_{JC}$  ): 22  $^{\circ}C$  / Watt
- Lead Soldering, Temp./Time: 260 °C, 10 Secs. Max.
- Header Finish: 100 to 250 μ inches nickel
- Lead Finish: 50 to 80 μ inches gold over 100 to 250 μ inches nickel

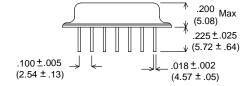
Hot Solder Tinning per MIL-PRF-55310 is optional at additional cost.

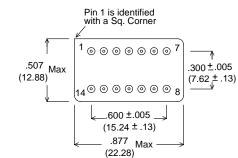
Contact Xsis Electronics at xsis@xsis.com for any special requirements.

### ORDERING INFORMATION (Please build your part number from options below):

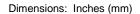


Xsis Electronics, Inc., 12620 W. 63rd St., Shawnee, KS 66216 Tel. 913-631-0448 Fax. 913-631-1170, www.xsis.com, email xsis@xsis.com





PIN #	FUNCTION			
14	GND/CASE			
7	- 5.2 VDC			
8	OUTPUT			
All Others	N/C			





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## **Electrical Specifications:**

Parameter	Specification Limits			
Output Frequency Range	10 MHz - 220 MHz			
Frequency Accuracy at +25 °C	<u>+</u> 15 PPM			
Frequency Stability Vs Temperature	See Ordering Information on Page 1			
Operating Temperature Range	See Ordering Information on Page 1			
Supply Voltage (Vdd)	- 5.2 VDC <u>+</u> 10%			
Input Current (no Load )	50 mA Max			
Output Waveform	Square Wave, ECL 10K & 10 KH Compatible			
Output Duty Cycle (at 50% Output Level)	60/40% Max.			
Output High Level	10K & 10 KH Compatible			
Output Low Level	10K & 10 KH Compatible			
Output Load	100 $\Omega$ to $$ - 2.0 VDC			
Rise & Fall Times (Typical Load)	2 nS Max.			
Start-Up Time	10 mS Max.			
Phase Jitter (10 KHz - 20 MHz Integrated)	0.10 pS rms Typical			
Freq. Stability Vs Supply Voltage	$\pm$ 4 PPM Max. for $\pm$ 10% change in Supply Voltage			
Aging at 70 °C	$\pm$ 3 PPM Max. first year, $\pm$ 2 PPM Max. per year thereafter			
Absolute Maximum Applied Voltage	+ 7 VDC			
Storage Temperature	-65 °C to +125 °C			

NOTE: For PECL applications, Xsis 300 Series oscillators can be operated with +5 VDC <u>+</u> 10% on Pin 14 and power supply return on Pin 7. Output signal can be AC or DC coupled.

For special requirements, such as, tighter output symmetry, faster start-up time, PIND screening, etc., please contact Xsis Electronics at xsis@xsis.com or call us at 913-631-0448.

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**Packaging:** ESD protective conductive foam tray.

### **Thermal Characteristics:**

Junction to case Thermal Constant ( $\theta_{JC}$ ): 22 °C / Watt Junction to Ambient (Device floating in free air) Thermal Constant ( $\theta_{JA}$ ): 85 °C / Watt

### **Hi-Rel Screening:**

When HI-REL option is selected, Xsis Oscillators are subjected to 100% screening similar to Class "S" screening in accordance with MIL-PRF-55310. Refer to <u>www.xsis.com</u> for additional details about HI-REL screening.

### Typical Phase Noise (dbc/Hz):

Output Frequency	10 Hz	100 Hz	1 KHz	10 KHz	100 KHz	1 MHz
10 MHz	-109	-140	-157	-162	-163	-164
25 MHz	-100	-127	-151	-158	-160	-162
50 MHz	-89	-117	-148	-157	-159	-160
96 MHz	-80	-107	-139	-151	-156	-158
100 MHz	-77	-104	-133	-145	-151	-155

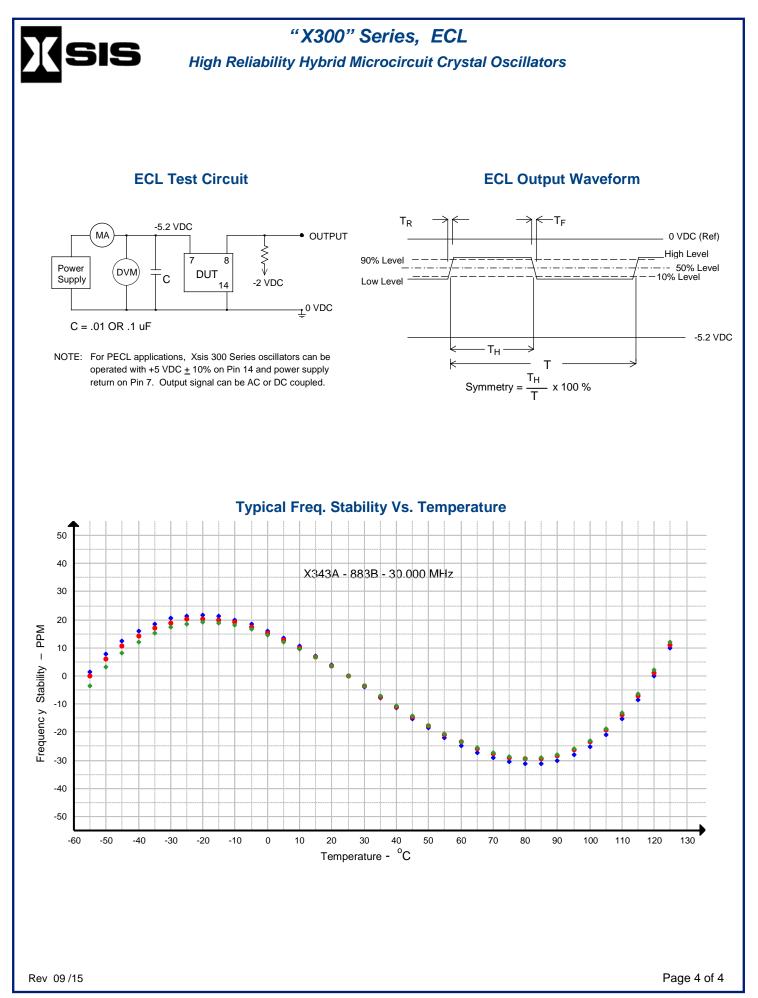
### **Environmental Specifications:**

X300 series oscillators are designed to meet or exceed the Environmental tests specified below. Customized screening and environmental testing are also available to meet your special requirements.

Test	Test Conditions		
Vibration	0.06" DA, 30 G peak, 10 - 2000 Hz, MIL-STD-202, Method 204, Cond. G		
Shock	1500 G, 0.5 mS, half-Sine, MIL-STD-883, Method 2002, Cond. B		
Temperature Cycling	MIL-STD-883, Method 1010, Cond. C		
Thermal Shock	MIL-STD-202, Method 107, Cond. B		
Seal (Fine and Gross)	MIL-STD-883, Method 1014 Cond. A & C		
Burn-in	160 Hours, 125 °C, Nominal Supply Voltage & Load		
Frequency Aging	30 days at 70 °C, $\pm$ 1.5 PPM Max.		
Altitude	MIL-STD-202, Method 105, Cond. C		
Constant Acceleration	MIL-STD-883, Method 2001, 5000 G		
Moisture Resistance	MIL-STD-202, Method 106, Vibration Sub Cycle Omitted		
Solderability	MIL-STD-202, Method 208		
Resistance to Soldering Heat	MIL-STD-202, Method 210, Cond B. or C as applicable		
Resistance to Solvents	MIL-STD-202, Method 215		
Internal Water Vapor Content	MIL-STD-883, Method 1018		
ESD Classification	MIL-STD-883, Method 3015, Class 1C, HBM 1000 to 1999		
Moisture Sensitivity Level	J-STD-020, MSL=1		

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